Power Products Division

Advance Information

SINGLE CHANNEL DRIVER

MPIC2117

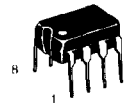
SINGLE CHANNEL DRIVER

The MPIC2117 is a high voltage, high speed, power MOSFET and IGBT driver. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS outputs. The output drivers feature a high pulse current buffer stage designed for minimum driver cross–conduction. The floating channel can be used to drive an N–channel power MOSFET or IGBT in the high side or low side configuration which operates from 10 to 600 volts.

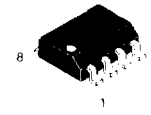
- Floating Channel Designed for Bootstrap Operation
- Fully Operational to +600 V
- Tolerant to Negative Transient Voltage
- dV/dt Immune
- Gate Drive Supply Range from 10 to 20 V
- Undervoltage Lockout
- CMOS Schmitt–triggered Input with Pull–down
- Output In Phase with Input

PRODUCT SUMMARY

V_{OFFSET}	600 V MAX
$I_{O+/-}$	200 mA/420 mA
V_{OUT}	10 – 20 V
$t_{on/off}$ (typical)	125 & 105 ns



P SUFFIX
PLASTIC PACKAGE
CASE 626–05



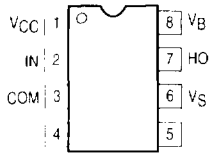
D SUFFIX
PLASTIC PACKAGE
CASE 751–05
(SO–8)

ORDERING INFORMATION

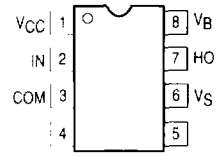
Device	Package
MPIC2117D	SOIC
MPIC2117P	PDIP

PIN CONNECTIONS

(TOP VIEW)



8 LEADS DIP
MPIC2117P



8 LEAD SOIC
MPIC2117D

This document contains information on a new product. Specifications and information herein are subject to change without notice.

REV 1

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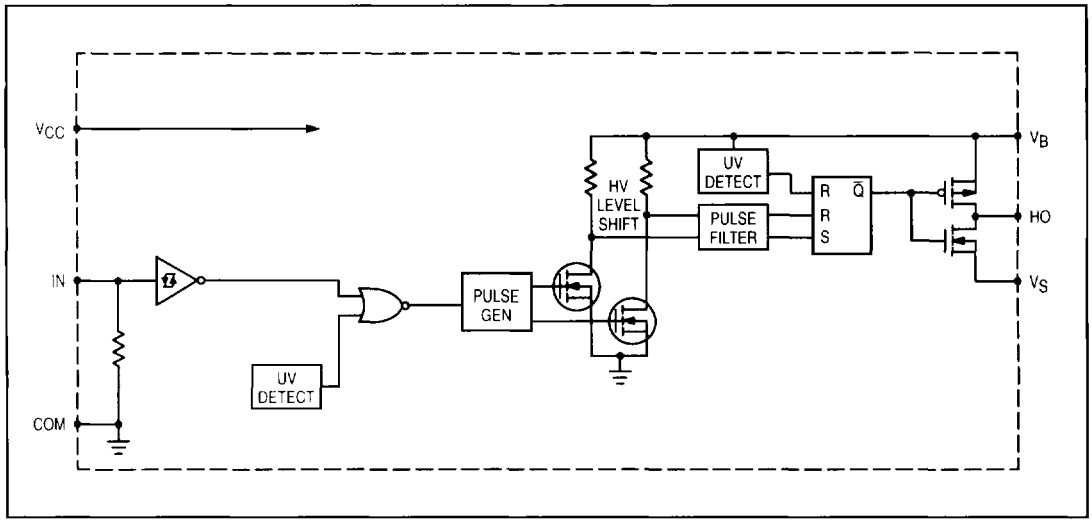
SIMPLIFIED BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

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Rating		Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage High Side Floating Supply Offset Voltage High Side Floating Output Voltage Logic Supply Voltage Logic Input Voltage		V_B V_S V_{HO} V_{CC} V_{IN}	−0.3 V_B−25 V_S−0.3 −0.3 −0.3	625 V_B+0.3 V_B+0.3 25 V_{CC}+0.3	V_{DC}
Allowable Offset Supply Voltage Transient		dV_S/dt	–	50	V/ns
*Package Power Dissipation @ $T_A \leq +25$ C	(8 Lead DIP) (8 Lead SOIC)	P_D –	– –	1.0 0.625	Watt
Thermal Resistance, Junction to Ambient	(8 Lead DIP) (8 Lead SOIC)	$R_{\theta JA}$	– –	125 200	C/W
Operating and Storage Temperature		T_j, T_{stg}	−55	150	C
Lead Temperature for Soldering Purposes, 10 seconds		T_L	–	260	C

RECOMMENDED OPERATING CONDITIONS

The Input/Output logic timing Diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S offset rating is tested with all supplies biased at 15 V differential.

High Side Floating Supply Absolute Voltage	V_B	V_S+10	V_S+20	V
High Side Floating Supply Offset Voltage	V_S	Note 1	600	
High Side Floating Output Voltage	V_{HO}	V_S	V_B	
Logic Supply Voltage	V_{CC}	10	20	
Logic Input Voltage	V_{IN}	0	V_{CC}	
Ambient Temperature	T_A	−40	125	C

Note 1: Logic operational for V_S of −5 to +600 V. Logic state held for V_S of −5 V to $-V_{BS}$.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit
STATIC ELECTRICAL CHARACTERISTICS					
V_{BIAS} (V_{CC}, V_{BS}) = 15 V unless otherwise specified. The V_{IN}, V_{TH} and I_{IN} parameters are referenced to COM. The VO and IO parameters are referenced to COM and are applicable to the respective output leads: HO or LO.					
Logic "1" Input Voltage @ V_{CC} = 10 V	V_{IH}	6.4	–	–	V_{DC}
Logic "1" Input Voltage @ V_{CC} = 15 V	V_{IH}	9.5	–	–	
Logic "1" Input Voltage @ V_{CC} = 20 V	V_{IH}	12.6	–	–	
Logic "0" Input Voltage @ V_{CC} = 10 V	V_{IL}	–	–	3.8	
Logic "0" Input Voltage @ V_{CC} = 15 V	V_{IL}	–	–	6.0	
Logic "0" Input Voltage @ V_{CC} = 20 V	V_{IL}	–	–	8.3	
High Level Output Voltage, V_{BS}–V_O @ V_{IN} = V_{IH}, I_O = 0 A	V_{OH}	–	–	100	mV
Low Level Output Voltage, V_O @ V_{IN} = V_{IL}, I_O = 0 A	V_{OL}	–	–	100	
Offset Supply Leakage Current @ V_B = V_S = 600 V	I_{LK}	–	–	50	µA
Quiescent V_{BS} Supply Current @ V_{IN} = 0 V or V_{CC}	I_{QBS}	–	50	–	
Quiescent V_{CC} Supply Current @ V_{IN} = 0 V or V_{CC}	I_{QCC}	–	70	–	
Logic "1" Input Bias Current @ V_{IN} = 15 V	I_{IN+}	–	20	40	
Logic "0" Input Bias Current @ V_{IN} = 0 V	I_{IN-}	–	–	1.0	
V_{BS} Supply Undervoltage Positive Going Threshold	V_{BSUV+}	–	8.5	–	V
V_{BS} Supply Undervoltage Negative Going Threshold	V_{BSUV-}	–	8.2	–	
V_{CC} Supply Undervoltage Positive Going Threshold	V_{CCUV+}	–	8.6	–	
V_{CC} Supply Undervoltage Negative Going Threshold	V_{CCUV-}	–	8.2	–	
Output High Short Circuit Pulsed Current @ V_{OUT} = 0 V, V_{IN} = 15 V, PW ≤ 10 µs	I_{O+}	200	250	–	mA
Output Low Short Circuit Pulsed Current @ V_{OUT} = 15 V, V_{IN} = 0 V, PW ≤ 10 µs	I_{O-}	420	500	–	
DYNAMIC ELECTRICAL CHARACTERISTICS					
V_{BIAS} (V_{CC}, V_{BS}) = 15 V unless otherwise specified					
Turn–On Propagation Delay @ V_S = 0 V	t_{on}	–	125	–	ns
Turn–Off Propagation Delay @ V_S = 600 V	t_{off}	–	105	–	
Turn–On Rise Time @ C_L = 1000 pF	t_r	–	80	–	
Turn–Off Fall Time @ C_L = 1000 pF	t_f	–	40	–	

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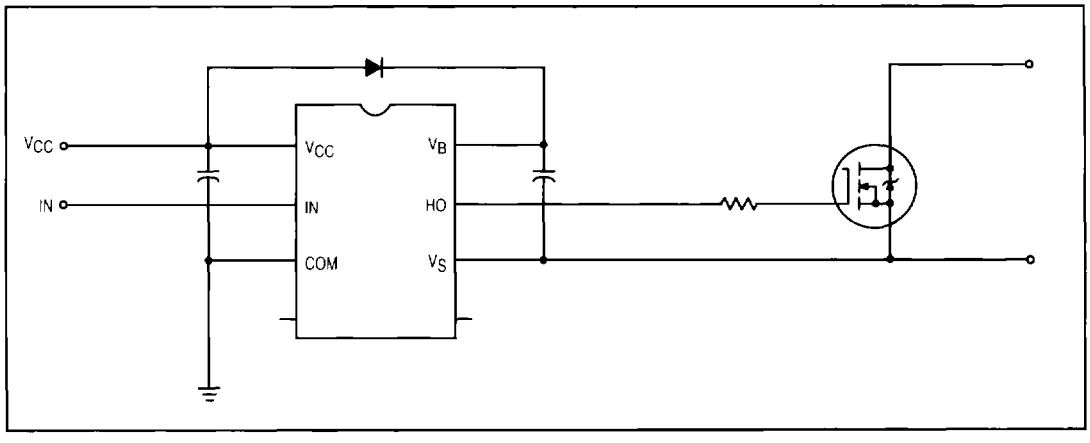
TYPICAL CONNECTION



LEAD DEFINITIONS

Symbol	Lead Description
V_{CC}	Logic Supply
IN	Logic Input for High Side Gate Driver Outputs (HO), In Phase with HO
COM	Logic Ground
V_B	High Side Floating Supply
HO	High Side Gate Drive Output
V_S	High Side Floating Supply Return

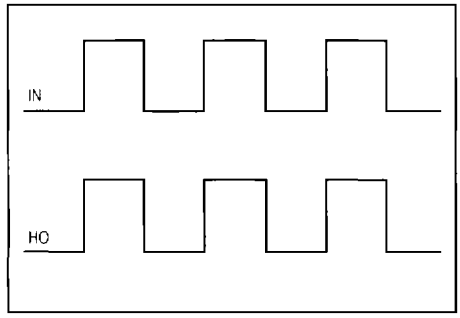


Figure 1. Input / Output Timing Diagram

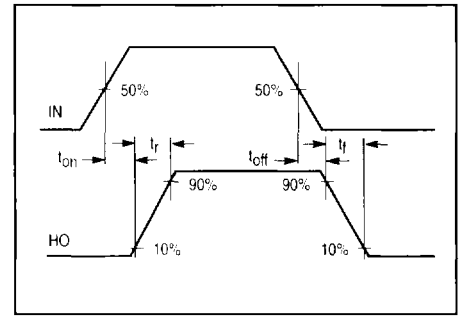


Figure 2. Switching Time Waveform Definitions